

HD74HC125, HD74HC126

Quad. Bus Buffer Gates (with 3-state outputs)

REJ03D0565-0300

Rev.3.00

Mar 25, 2009

Description

The HD74HC125, HD74HC126 require the 3-state control input C to be taken high to put the output into the high impedance condition, whereas the HD74HC125, HD74HC126 requires the control input to be low to put the output into high impedance.

Features

- High Speed Operation: $t_{pd} = 8 \text{ ns typ (} C_L = 50 \text{ pF)}$
- High Output Current: Fanout of 15 LSTTL Loads
- Wide Operating Voltage: $V_{CC} = 2 \text{ to } 6 \text{ V}$
- Low Input Current: $1 \mu\text{A max}$
- Low Quiescent Supply Current: $I_{CC} \text{ (static)} = 4 \mu\text{A max (} T_a = 25^\circ\text{C)}$
- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HC125P HD74HC126P	DILP-14 pin	PRDP0014AB-B (DP-14AV)	P	—
HD74HC125FPEL HD74HC126FPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)
HD74HC125RPEL HD74HC126RPEL	SOP-14 pin (JEDEC)	PRSP0014DE-A (FP-14DNV)	RP	EL (2,500 pcs/reel)
HD74HC125TELL HD74HC126TELL	TSSOP-14 pin	PTSP0014JA-B (TTP-14DV)	T	ELL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

Function Table

Inputs			Output	
C		A	Y	
HC125	HC126		HC125	HC126
H	L	X	Z	Z
L	H	L	L	L
L	H	H	H	H

H: High level

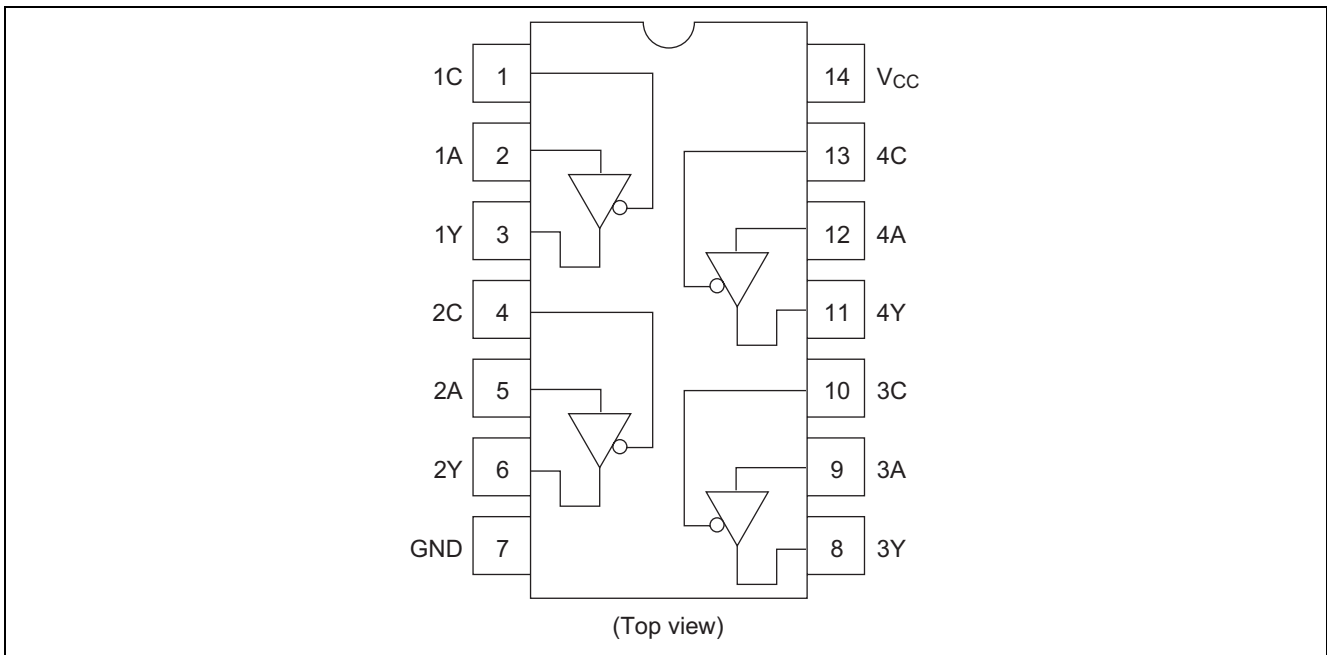
L: Low level

X: Irrelevant

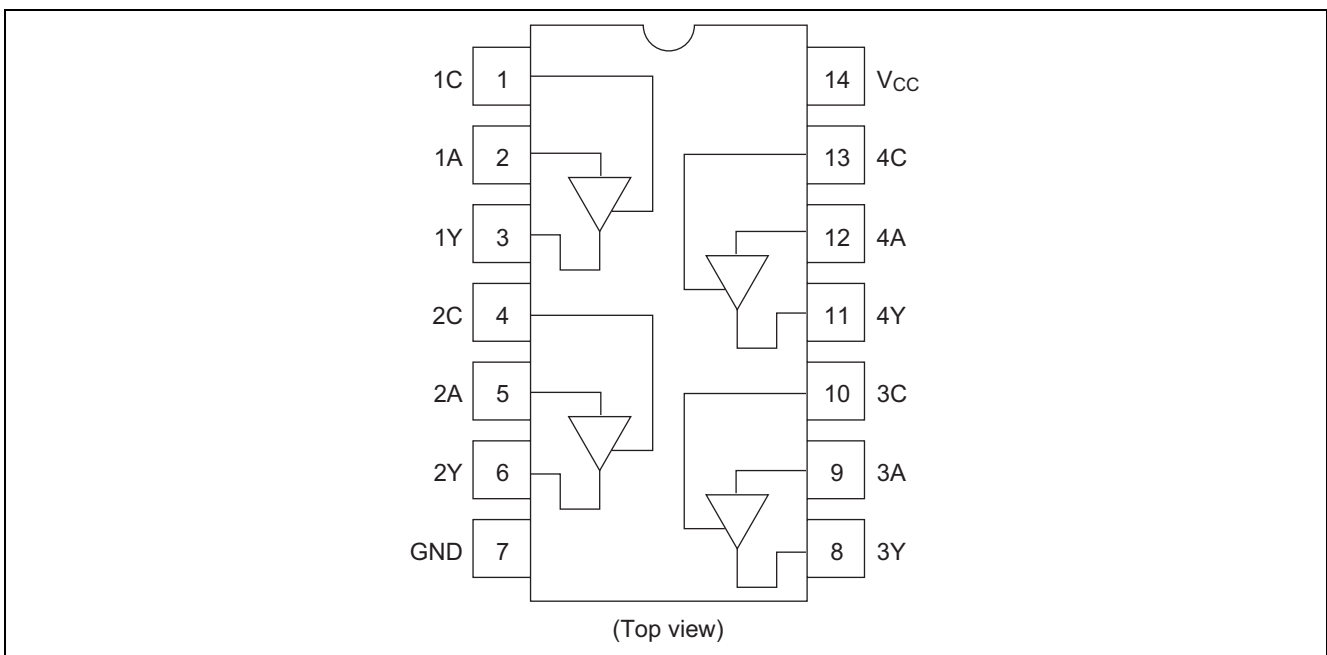
Z: Off (high-impedance) state of a 3-state output.

Pin Arrangement

- HD74HC125



- HD74HC126



Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Supply voltage range	V_{CC}	-0.5 to +7.0	V
Input voltage	V_{IN}	-0.5 to $V_{CC} + 0.5$	V
Output voltage	V_{OUT}	-0.5 to $V_{CC} + 0.5$	V
Output current	I_{OUT}	± 35	mA
DC current drain per V_{CC} , GND	I_{CC} , I_{GND}	± 75	mA
DC input diode current	I_{IK}	± 20	mA
DC output diode current	I_{OK}	± 20	mA
Power dissipation per package	P_T	500	mW
Storage temperature	T_{stg}	-65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V_{CC}	2 to 6	V	
Input / Output voltage	V_{IN} , V_{OUT}	0 to V_{CC}	V	
Operating temperature	T_a	-40 to 85	°C	
Input rise / fall time ^{*1}	t_r , t_f	0 to 1000	ns	$V_{CC} = 2.0$ V
		0 to 500		$V_{CC} = 4.5$ V
		0 to 400		$V_{CC} = 6.0$ V

Note: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

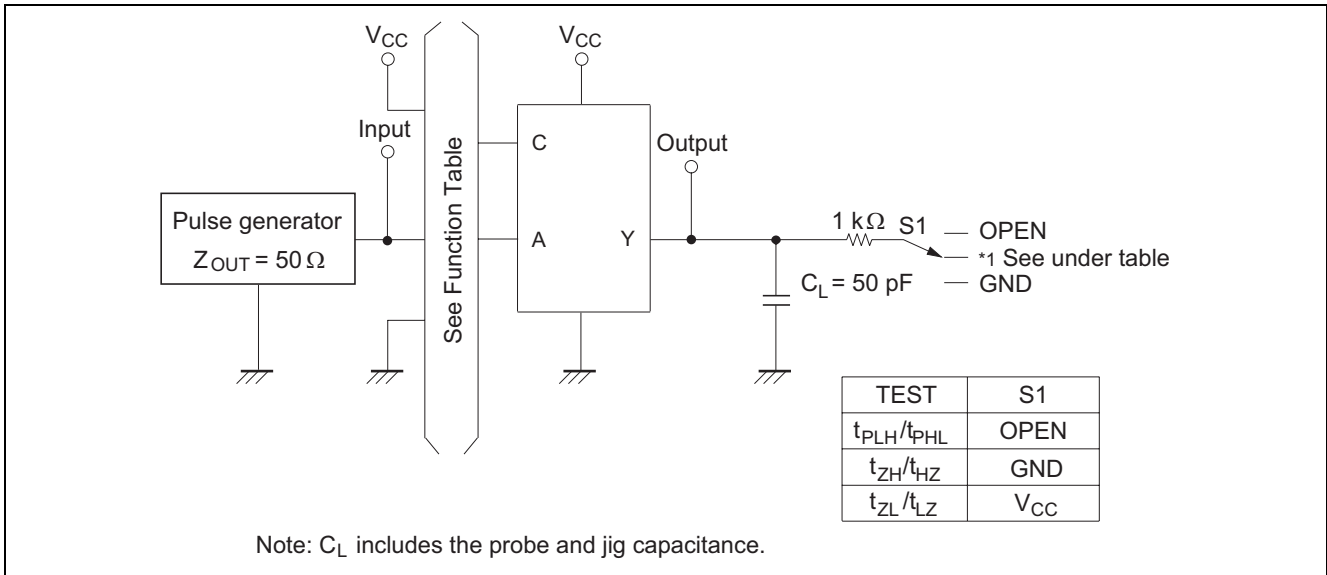
Electrical Characteristics

Item	Symbol	V_{CC} (V)	$T_a = 25^\circ\text{C}$			$T_a = -40 \text{ to } +85^\circ\text{C}$		Unit	Test Conditions				
			Min	Typ	Max	Min	Max						
Input voltage	V_{IH}	2.0	1.5	—	—	1.5	—	V					
		4.5	3.15	—	—	3.15	—						
		6.0	4.2	—	—	4.2	—						
	V_{IL}	2.0	—	—	0.5	—	0.5				V		
		4.5	—	—	1.35	—	1.35						
		6.0	—	—	1.8	—	1.8						
Output voltage	V_{OH}	2.0	1.9	2.0	—	1.9	—	V	$V_{in} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -20 \mu\text{A}$			
		4.5	4.4	4.5	—	4.4	—			$I_{OH} = -6 \text{ mA}$			
		6.0	5.9	6.0	—	5.9	—			$I_{OH} = -7.8 \text{ mA}$			
		4.5	4.18	—	—	4.13	—						
		6.0	5.68	—	—	5.63	—						
	V_{OL}	2.0	—	0.0	0.1	—	0.1	V	$V_{in} = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 20 \mu\text{A}$			
		4.5	—	0.0	0.1	—	0.1			$I_{OL} = 6 \text{ mA}$			
		6.0	—	0.0	0.1	—	0.1			$I_{OL} = 7.8 \text{ mA}$			
		4.5	—	—	0.26	—	0.33						
		6.0	—	—	0.26	—	0.33						
Off-state output current	I_{OZ}	6.0	—	—	± 0.5	—	± 5.0	μA	$V_{in} = V_{IH} \text{ or } V_{IL}$, $V_{out} = V_{CC} \text{ or } \text{GND}$				
Input current	I_{in}	6.0	—	—	± 0.1	—	± 1.0	μA	$V_{in} = V_{CC} \text{ or } \text{GND}$				
Quiescent supply current	I_{CC}	6.0	—	—	4.0	—	40	μA	$V_{in} = V_{CC} \text{ or } \text{GND}$, $I_{out} = 0 \mu\text{A}$				

Switching Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

Item	Symbol	V_{CC} (V)	$T_a = 25^\circ\text{C}$			$T_a = -40 \text{ to } +85^\circ\text{C}$		Unit	Test Conditions
			Min	Typ	Max	Min	Max		
Propagation delay time	t_{PLH}, t_{PHL}	2.0	—	—	100	—	125	ns	
		4.5	—	8	20	—	25		
		6.0	—	—	17	—	21		
Output enable Time	t_{ZH}, t_{ZL}	2.0	—	—	150	—	190	ns	
		4.5	—	9	30	—	38		
		6.0	—	—	26	—	33		
Output disable Time	t_{HZ}, t_{LZ}	2.0	—	—	150	—	190	ns	
		4.5	—	14	30	—	38		
		6.0	—	—	26	—	33		
Output rise/fall time	t_{TLH}, t_{THL}	2.0	—	—	60	—	75	ns	
		4.5	—	4	12	—	15		
		6.0	—	—	10	—	13		
Input capacitance	C_{in}	—	—	5	10	—	10	pF	

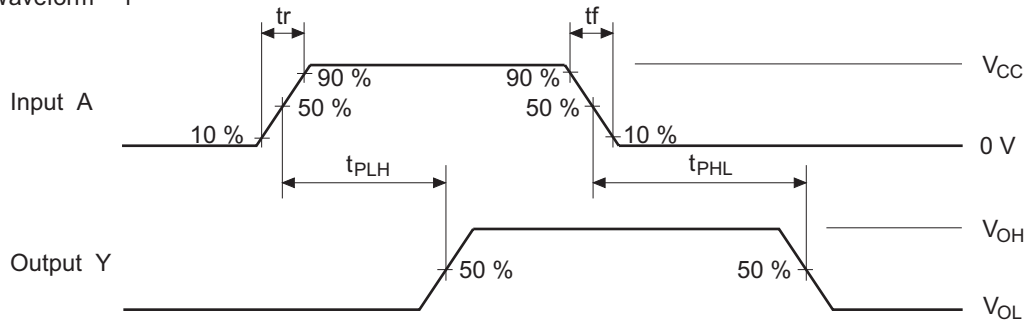
Test Circuit



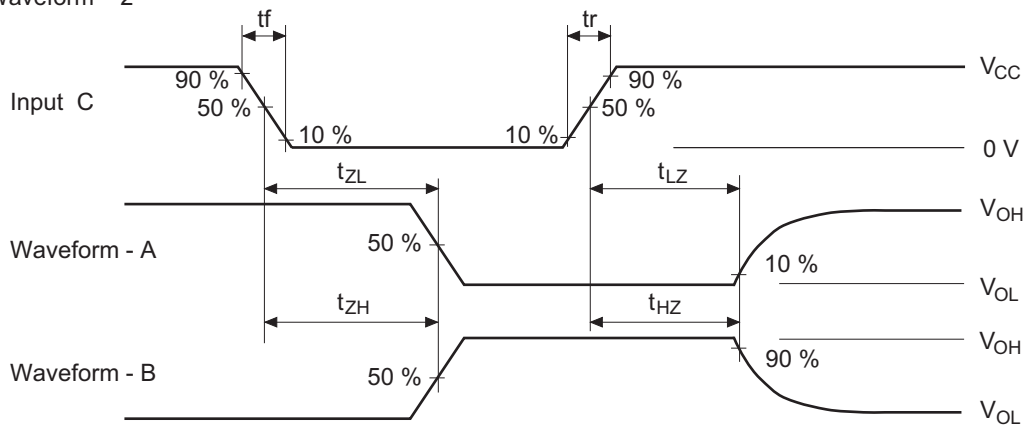
Waveforms

- HD74HC125

• Waveform – 1



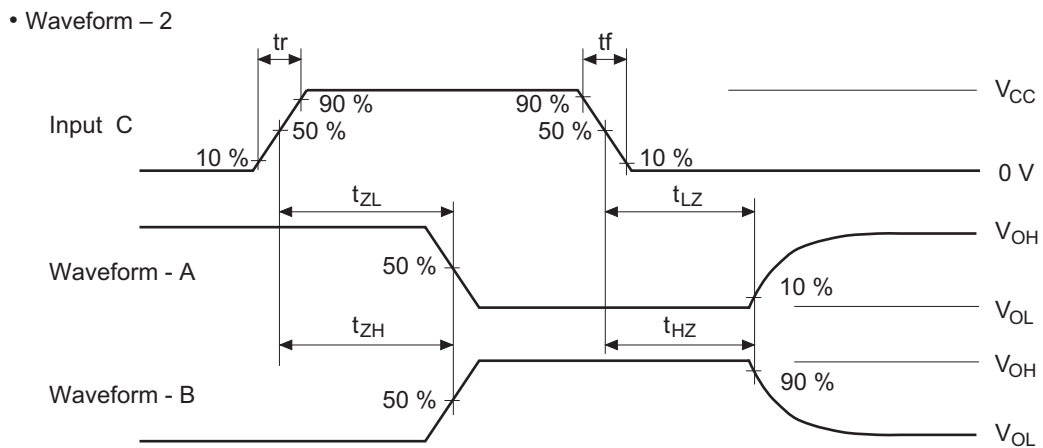
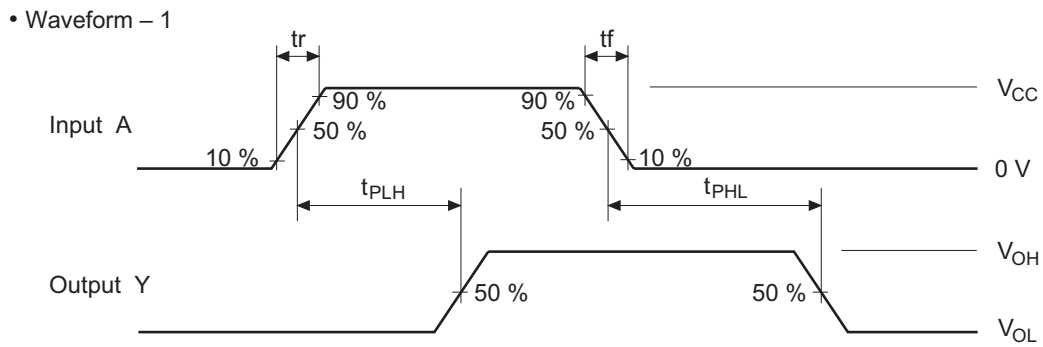
• Waveform – 2



- Notes :
1. $t_r \leq 6 \text{ ns}$, $t_f \leq 6 \text{ ns}$
 2. Input waveform : $\text{PRR} \leq 1 \text{ MHz}$, duty cycle 50%
 3. Waveform– A is for an output with internal conditions such that the output is low except when disabled by the output control.
 4. Waveform– B is for an output with internal conditions such that the output is high except when disabled by the output control.

Waveforms

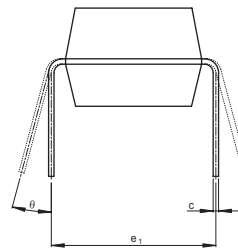
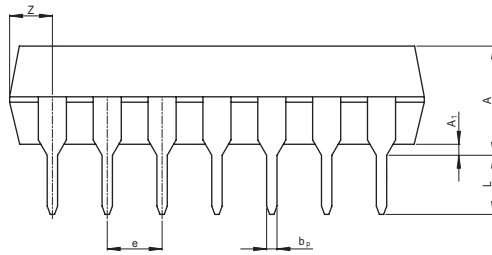
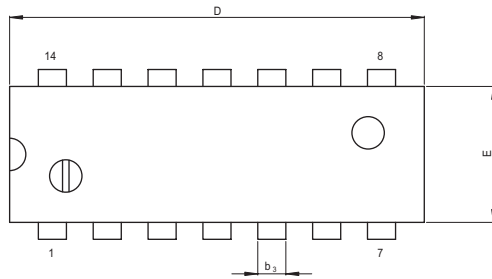
- HD74HC126



- Notes :
1. $t_r \leq 6 \text{ ns}$, $t_f \leq 6 \text{ ns}$
 2. Input waveform : PRR $\leq 1 \text{ MHz}$, duty cycle 50%
 3. Waveform– A is for an output with internal conditions such that the output is low except when disabled by the output control.
 4. Waveform– B is for an output with internal conditions such that the output is high except when disabled by the output control.

Package Dimensions

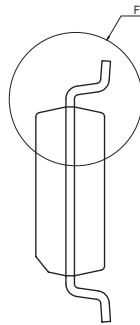
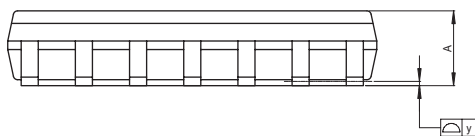
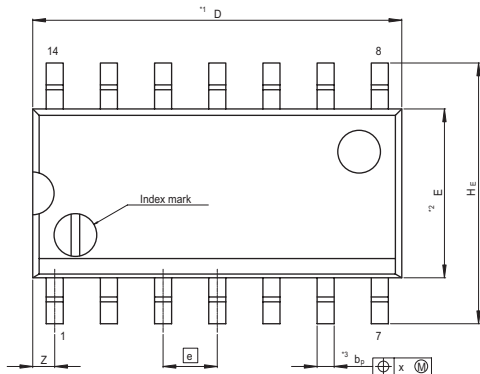
JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-DIP14-6.3x19.2-2.54	PRDP0014AB-B	DP-14AV	0.97g



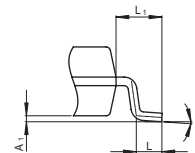
(Ni/Pd/Au plating)

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
e ₁	—	7.62	—
D	—	19.2	20.32
E	—	6.3	7.4
A	—	—	5.06
A ₁	0.51	—	—
b _p	0.40	0.48	0.56
b ₃	—	1.30	—
c	0.19	0.25	0.31
θ	0°	—	15°
e	2.29	2.54	2.79
Z	—	—	2.39
L	2.54	—	—

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-SOP14-3.95x8.65-1.27	PRSP0014DE-A	FP-14DNV	0.13g



Terminal cross section
(Ni/Pd/Au plating)



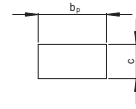
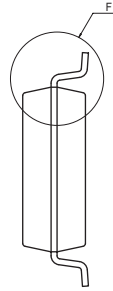
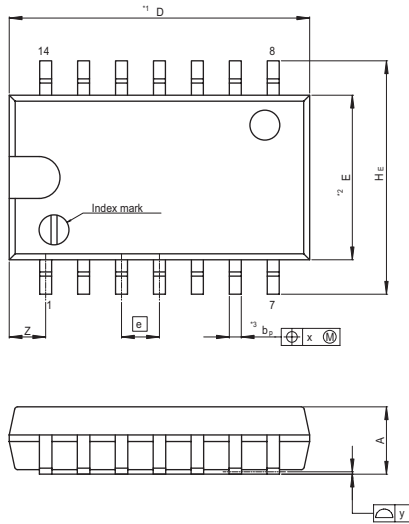
Detail F

NOTE:
1. DIMENSIONS*1 (Nom)*AND*2* DO NOT INCLUDE MOLD FLASH.
2. DIMENSION*3*DOES NOT INCLUDE TRIM OFFSET.

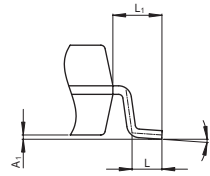
Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	8.65	9.05
E	—	3.95	—
A ₂	—	—	—
A ₁	0.10	0.14	0.25
A	—	—	1.75
b _p	0.34	0.40	0.46
b ₁	—	—	—
c	0.15	0.20	0.25
c ₁	—	—	—
θ	0°	—	8°
HE	5.80	6.10	6.20
Ⓜ	—	1.27	—
x	—	—	0.25
y	—	—	0.15
Z	—	—	0.635
L	0.40	0.60	1.27
L ₁	—	1.08	—

HD74HC125, HD74HC126

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-SOP14-5.5x10.06-1.27	PRSP0014DF-B	FP-14DAV	0.23g



Terminal cross section
(Ni/Pd/Au plating)

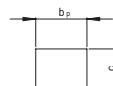
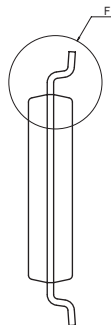
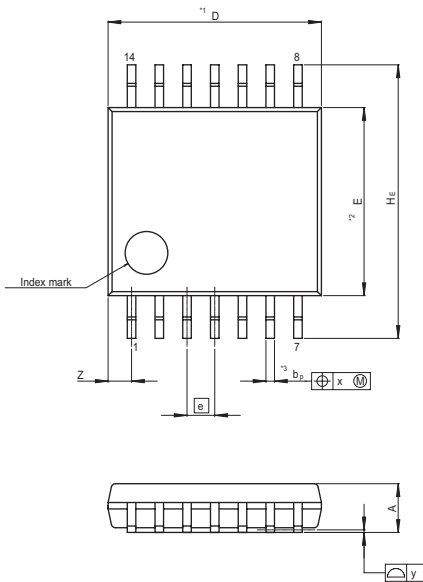


Detail F

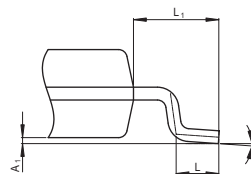
NOTE)
1. DIMENSIONS**1 (Nom)**AND**2*
DO NOT INCLUDE MOLD FLASH.
2. DIMENSION**3*DOES NOT
INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	10.06	10.5
E	—	5.50	—
A ₂	—	—	—
A ₁	0.00	0.10	0.20
A	—	—	2.20
b _P	0.34	0.40	0.46
b ₁	—	—	—
c	0.15	0.20	0.25
c ₁	—	—	—
θ	0°	—	8°
H _E	7.50	7.80	8.00
Ⓜ	—	1.27	—
x	—	—	0.12
y	—	—	0.15
Z	—	—	1.42
L	0.50	0.70	0.90
L ₁	—	1.15	—

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-TSSOP14-4.4x5-0.65	PTSP0014JA-B	TTP-14DV	0.05g



Terminal cross section
(Ni/Pd/Au plating)



Detail F

NOTE)
1. DIMENSIONS**1 (Nom)**AND**2*
DO NOT INCLUDE MOLD FLASH.
2. DIMENSION**3*DOES NOT
INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	5.00	5.30
E	—	4.40	—
A ₂	—	—	—
A ₁	0.03	0.07	0.10
A	—	—	1.10
b _P	0.15	0.20	0.25
b ₁	—	—	—
c	0.10	0.15	0.20
c ₁	—	—	—
θ	0°	—	8°
H _E	6.20	6.40	6.60
Ⓜ	—	0.65	—
x	—	—	0.13
y	—	—	0.10
Z	—	—	0.83
L	0.4	0.5	0.6
L ₁	—	1.0	—

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